



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

application of

: **Confirmation No. 9620**

Masanobu NOGOME et al.

: Docket No. 2003_1075A

Serial No. 10/630,900

: Group Art Unit 2818

Filed July 31, 2003

: Examiner Mai Huong Tran

SEMICONDUCTOR DEVICE AND
MANUFACTURING METHOD THEREOF

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Responsive to the Office Action dated March 22, 2005, please amend the
above-identified application as follows.

AMENDMENT TO THE TITLE

Please replace the original title with following rewritten title.

“Semiconductor Device Including a Photosensitive Resin Covering at Least a Portion of a Substrate Having a Via Hole”